



SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(TYP)} @ 1A (V)	I _{R(TYP)} @V _R =30V (μΑ)
40	1	0.425	50

Description and Applications

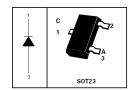
- DC DC Converters
- Mobile Telecomms
- PCMIA & SCSI

Features and Benefits

- High current capability ($I_F = 1A$)
- Low V_F
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.0089 grams (approximate)



Top View

Ordering Information (Note 4)

Device	Packaging	Shipping		
ZHCS1000TA	SOT23	3000/Tape & Reel		
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.				

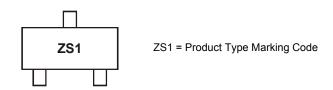
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Continuous Reverse Voltage		V _R	40	V
Continuous Forward Current		lF	1	А
Forward Voltage @ I _F = 1A (typ)		V _F	425	mV
Average Peak Forward Current; D.C. = 50%		I _{FAV}	1750	mA
Non Repetitive Forward Current	t ≤ 100µs		12	Α
	t ≤ 10ms	IFSM	5.2	A

Thermal Characteristics

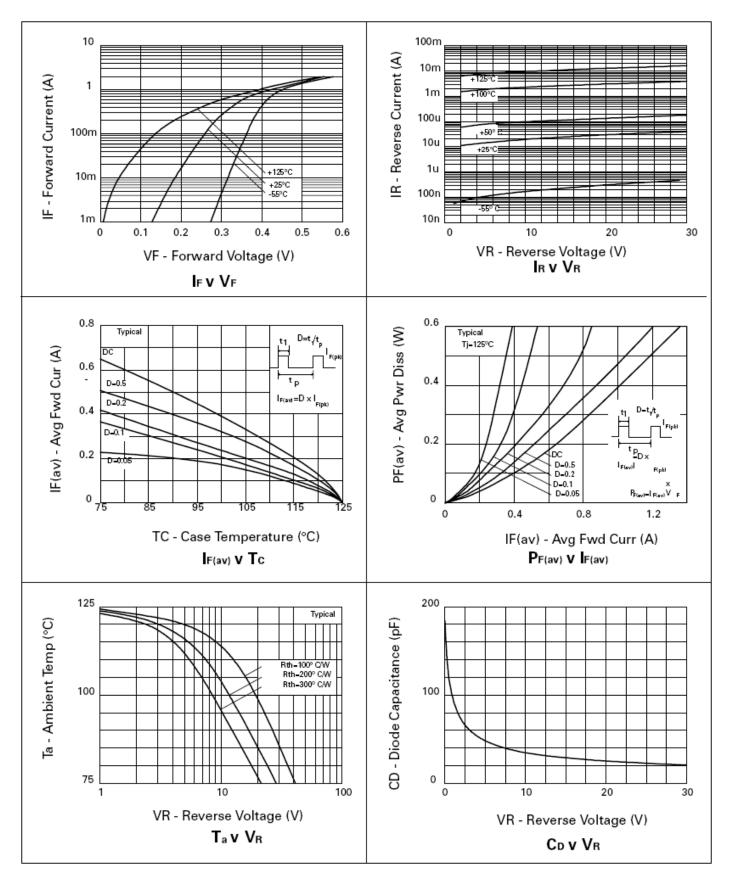
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Characteristic	Symbol	Value	Unit
Power Dissipation, $T_A = +25^{\circ}C$	PD	500	mW
Junction Temperature	TJ	+125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

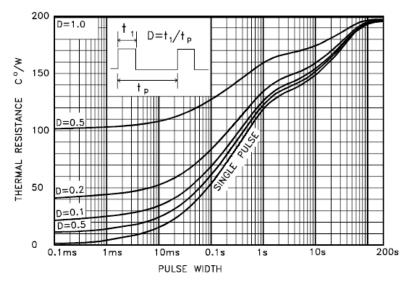
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	60	_	V	I _R = 300μA
		_	240	270	mV	I _F = 50mA
	VF	_	265	290		I _F = 100mA
		_	305	340		I _F = 250mA
Forward Valtage (Note E)		_	355	400		I _F = 500mA
Forward Voltage (Note 5)		_	390	450		I _F = 750mA
		_	425	500		I _F = 1A
		_	495	600		I _F = 1.5A
		_	420			I _F = 1A, T _A = +100°C
Reverse Current (Note 6)	I _R	—	50	100	μA	V _R = 30V
Total Capacitance	CT	_	25	_	pF	f = 1MHz, V _R = 30V
Reverse Recovery Time	trr	_	12	_	ns	Switched from $I_F = 500$ mA to $I_R = 500$ mA Measured @ $I_R = 50$ mA

 Measured under pulsed conditions. Pulse width = 300µS.
Short duration pulse test used to minimize self-heating effect. Notes:







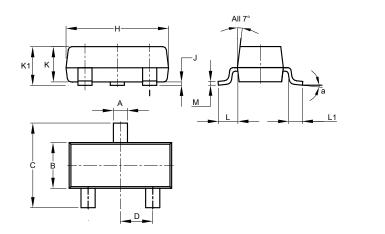


MAXIMUM TRANSIENT THERMAL RESISTANCE*

* Devices were mounted on a 15mmx15mm ceramic substrate.

Package Outline Dimensions

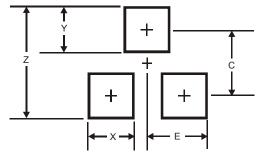
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
κ	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	8°				
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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